This announcement is made by Semiconductor Manufacturing International Corporation (the “Company”) pursuant to rule 13.09 of the Rules Governing the Listing of Securities on The Stock Exchange of Hong Kong Limited and the Inside Information Provisions of Part XIVA of the Securities and Futures Ordinance (Chapter 571 of the Laws of Hong Kong).

On 18 December 2020, the Company noted that the Department of Commerce (the “U.S. Commerce Department”) of the United States of America (the “U.S.”) added the Company and certain subsidiaries and an associated company to the Entity List for the protection of the U.S. national security and foreign policy interests.

After the Company was added to the Entity List, suppliers of items or technologies subject to the U.S. Export Administration Regulations shall be required to apply for an export license with the U.S. Commerce Department for supplying such items or technologies to the Company pursuant to the requirements under the relevant U.S. laws and regulations. For items or technologies uniquely utilized for 10 nanometers and below technology nodes (including extreme ultraviolet technology), a licensing review policy of presumption of denial shall be applied by the U.S. Commerce Department for respective export license applications. The Company may also be subject to certain restrictions on providing foundry services to certain customers.

Since the Company noted from the news on 5 September 2020 that it may be added to the trade blacklist by the U.S. Commerce Department, it has made every effort to communicate with relevant agencies of the U.S. Government in the hopes of receiving fair and just treatments. Regrettably, the Company was still added to the Entity List. In this regard, the Company expresses its firm opposition and reiterates that it has always abided by the principles of compliant operations and the laws and regulations of relevant jurisdictions where it conducts its operations and businesses, and has never been involved in any operation involving military applications since its incorporation.
Based on the Company’s preliminary assessment, the abovementioned matters have no material adverse effect on the Company’s short-term operations and financial positions, but will have a material adverse effect on the research and development and capacity construction of 10 nanometers and below advanced technology nodes. The Company will continue to communicate with relevant agencies of the U.S. Government and take all feasible measures as appropriate to actively try to reach a resolution and minimize the adverse effect.

Any further announcement in respect of the development of the abovementioned matters will be made as and when appropriate in accordance with the applicable listing rules and laws of the places where the Company’s shares are listed.

Shareholders and prospective investors are advised to exercise caution when dealing in the securities of the Company.

By order of the Board
Semiconductor Manufacturing International Corporation
Gao Yonggang
Executive Director, Chief Financial Officer and Company Secretary

Shanghai, PRC
20 December 2020

As at the date of this announcement, the directors of the Company are:

Executive Directors
ZHOU Zixue (Chairman)
CHIANG Shang-Yi (Vice Chairman)
ZHAO Haijun (Co-Chief Executive Officer)
LIANG Mong Song (Co-Chief Executive Officer)
GAO Yonggang (Chief Financial Officer and Company Secretary)

Non-executive Directors
CHEN Shanzhi
ZHOU Jie
REN Kai
LU Jun
TONG Guohua

Independent Non-executive Directors
William Tudor BROWN
CONG Jingsheng Jason
LAU Lawrence Juen-Yee
FAN Ren Da Anthony
YOUNG Kwang Leei

* For identification purposes only